EcoSPARK[®] 3 Ignition IGBT

270 mJ, 360 V, N-Channel Ignition IGBT

Features

- SCIS Energy = 270 mJ at $T_J = 25^{\circ}C$
- Logic Level Gate Drive
- Low Saturation Voltage
- RoHS Compliant
- AEC-Q101 Qualified and PPAP Capable

Applications

- Automotive Ignition Coil Driver Circuits
- High Current Ignition System
- Coil on Plug Applications

MAXIMUM RATINGS (T_J = 25° C unless otherwise stated)

Symbol	Parameter	Value	Units	
BV _{CER}	Collector-to-Emitter Breakdown Voltage (I _C = 1 mA)	360	V	
BV _{ECS}	Emitter-to-Collector Voltage – Reverse Battery Condition (I _C = 10 mA)	28	V	
E _{SCIS25}	ISCIS = 13.4 A, L = 3.0 mHy, R _{GE} = 1 K Ω T _C = 25°C (Note 1)	270	mJ	
E _{SCIS150}	ISCIS = 10.8 A, L = 3.0 mHy, R _{GE} = 1 K Ω T _C = 150°C (Note 2)	170	mJ	
I _{C25}	Collector Current Continuous at V_{GE} = 5.0 V, T_{C} = 25°C	37.5	A	
I _{C110}	Collector Current Continuous at V _{GE} = 5.0 V, T _C = 110°C	24.3	A	
V _{GEM}	Gate-to-Emitter Voltage Continuous	±10	V	
PD	Power Dissipation Total, $T_C = 25^{\circ}C$	150	W	
	Power Dissipation Derating, $T_C > 25^{\circ}C$	1.1	W/°C	
T _J /T _{STG}	Operating Junction and Storage Temperature Range	-40 to +175	°C	
ΤL	Lead Temperature for Soldering Purposes (1/8" from case for 10 s)	300	°C	
T _{PKG}	Reflow soldering according to JESD020C	260	°C	
ESD	HBM – Electrostatic Discharge Voltage at 100 pF, 1500 Ω	4	kV	
	CDM – Electrostatic Discharge Voltage at 1 Ω	2	kV	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

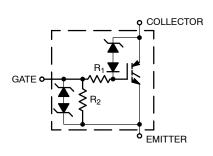
1. Self clamped inductive Switching Energy (ESCIS25) of 270 mJ is based on the test conditions that is starting $T_J = 25^{\circ}C$, L = 3 mHy, ISCIS = 13.4 A, VCC = 100 V during inductor charging and VCC = 0 V during time in clamp.

 Self Clamped inductive Switching Energy (ESCIS150) of 170 mJ is based on the test conditions that is starting T_J = 150°C, L = 3mHy, ISCIS = 10.8 A, VCC = 100 V during inductor charging and VCC = 0 V during time in clamp.



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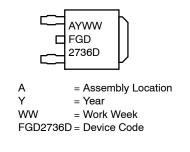
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DPAK (SINGLE GAUGE) CASE 369C

MARKING DIAGRAM



ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

THERMAL RESISTANCE RATINGS

Characteristic	Symbol	Мах	Units
Junction-to-Case – Steady State (Drain)		1.1	°C/W

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

Symbol	Parameter	Test Conditions		Min	Тур	Max	Units
OFF CHARA	ACTERISTICS						
BV _{CER}	Collector-to-Emitter Breakdown Voltage	$ I_{CE} = 2 \text{ mA}, V_{GE} = 0 \text{ V}, \\ R_{GE} = 1 k\Omega, T_{J} = -40 \text{ to } 150^{\circ}\text{C} $		330	_	390	V
BV _{CES}	Collector-to-Emitter Breakdown Voltage	$ I_{CE} = 10 \text{ mA}, V_{GE} = 0 \text{ V}, \\ R_{GE} = 0, T_J = -40 \text{ to } 150^\circ\text{C} $		350	-	410	V
BV _{ECS}	Emitter-to-Collector Breakdown Voltage	I_{CE} = -75 mA, V_{GE} = 0 V, T _J = 25°C		28	-	_	V
BV _{GES}	Gate-to-Emitter Breakdown Voltage	$I_{GES} = \pm 2 \text{ mA}$		±11	±14	-	V
I _{CER}	Collector-to-Emitter Leakage Current	V _{CE} = 175 V	$T_J = 25^{\circ}C$	-	-	25	μA
		$R_{GE} = 1 \ k\Omega$	$T_J = 150^{\circ}C$	-	-	1	mA
I _{ECS}	Emitter-to-Collector Leakage Current	V _{EC} = 24 V	$T_J = 25^{\circ}C$	-	-	1	mA
			$T_J = 150^{\circ}C$	-	_	40	
R ₁	Series Gate Resistance			-	110	_	Ω
R ₂	Gate-to-Emitter Resistance			10K	-	30K	Ω
N CHARAG	CTERISTICS						
V _{CE(SAT)}	Collector-to-Emitter Saturation Voltage	$I_{CE} = 6 \text{ A}, \text{ V}_{GE} = 4 \text{ V}, \text{ T}_{J} = 25^{\circ}\text{C}$		-	1.25	1.35	V
V _{CE(SAT)}	Collector-to-Emitter Saturation Voltage	I_{CE} = 10 A, V_{GE} = 4.5 V, T_{J} = 25°C		-	1.45	1.65	V
V _{CE(SAT)}	Collector-to-Emitter Saturation Voltage	I_{CE} = 10 A, V_{GE} = 4.5 V, T_{J} = 150°C		-	1.60	1.80	V
YNAMIC C	HARACTERISTICS						
Q _{G(ON)}	Gate Charge	I_{CE} = 10 A, V_{CE} = 12 V, V_{GE} = 5 V		-	18	-	nC
V _{GE(TH)}	Gate-to-Emitter Threshold Voltage	I _{CE} = 1 mA	$T_J = 25^{\circ}C$	1.3	1.6	2.2	V
		$V_{CE} = V_{GE}$ $T_J = 150^{\circ}C$		0.75	1.1	1.8	1

SWITCHING CHARACTERISTICS

 V_{GEP}

td _{(ON)R}	Current Turn-On Delay Time-Resistive	$V_{CE} = 14 \text{ V}, \text{ R}_{\text{L}} = 1 \Omega, \text{ V}_{\text{GE}} = 5 \text{ V},$	_	0.9	4	μs
t _{rR}	Current Rise Time-Resistive	R _G = 470 Ω, T _J = 25°C	-	3.0	7	
td _{(OFF)L}	Current Turn-Off Delay Time-Inductive	$V_{CE} = 300 \text{ V}, \text{ L} = 1 \text{ mH}, \text{ V}_{GE} = 5 \text{ V},$	-	4.4	15	
t _{fL}	Current Fall Time-Inductive	R_{G} = 470 Ω, I_{CE} = 6.5 A, T_{J} = 25°C	-	1.9	15	

V_{CE} = 12 V, I_{CE} = 10 A

3.0

V

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

PACKAGE MARKING AND DEVICE ORDERING INFORMATION

Gate-to-Emitter Plateau Voltage

Device Marking	Device	Package	Reel Diameter	Tape Width	Qty†
FGD2736G3	FGD2736G3-F085V	DPAK (Pb-Free)	330 mm	16 mm	2500

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

TYPICAL CHARACTERISTICS

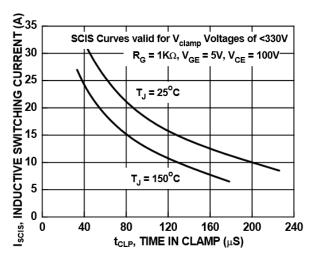
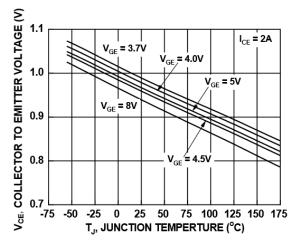
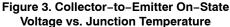


Figure 1. Self Clamped Inductive Switching Current vs. Time in Clamp





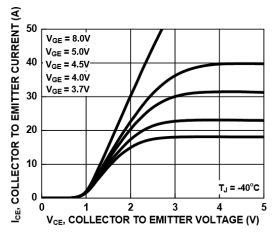
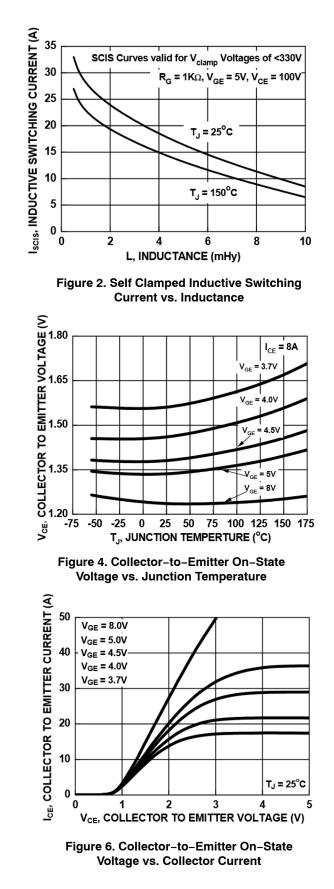
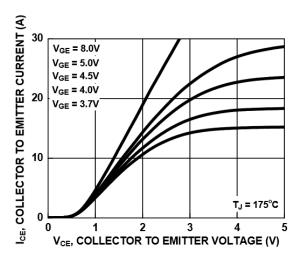


Figure 5. Collector-to-Emitter On-State Voltage vs. Collector Current



TYPICAL CHARACTERISTICS





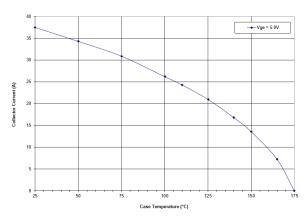


Figure 9. Current Derating

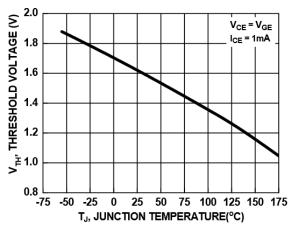


Figure 11. Threshold Voltage vs. Junction Temperature

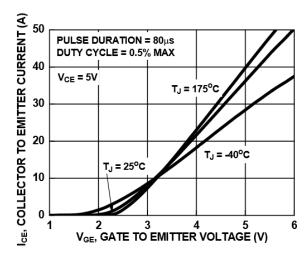


Figure 8. Transfer Characteristics

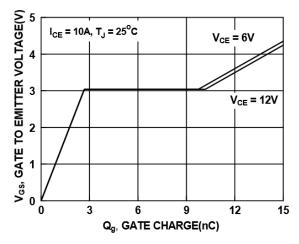
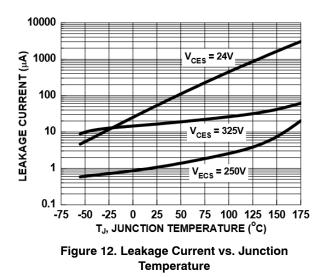


Figure 10. Gate Charge



TYPICAL CHARACTERISTICS

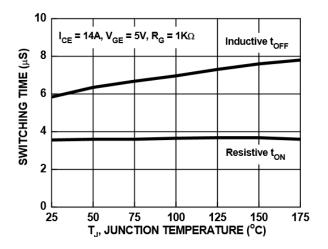


Figure 13. Switching Time vs. Junction Temperature

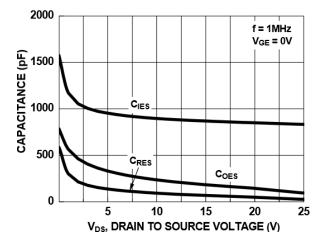


Figure 14. Capacitance vs. Collector-to-Emitter Voltage

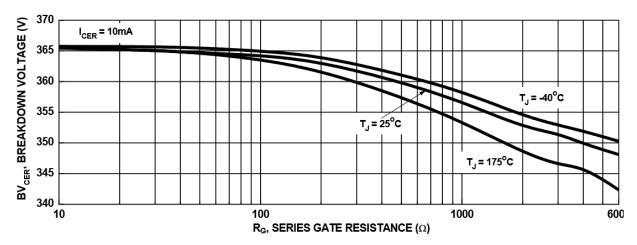
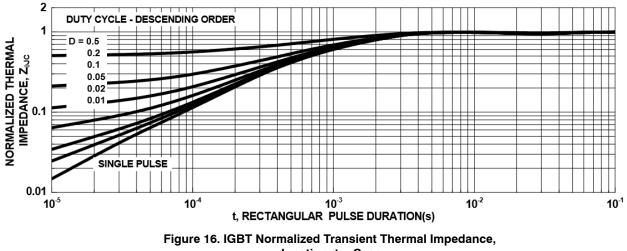


Figure 15. Break Down Voltage vs. Series Resistance



Junction-to-Case

TEST CIRCUITS AND WAVEFORMS

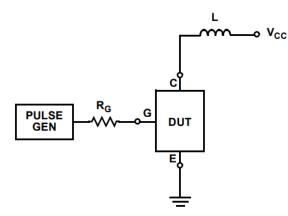


Figure 17. Inductive Switching Test Circuit

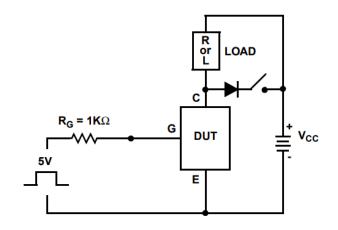


Figure 18. t_{ON} and t_{OFF} Switching Test Circuit

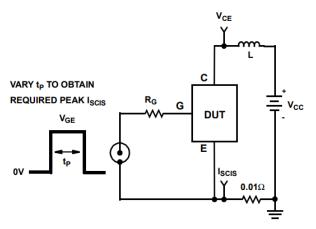


Figure 19. Energy Test Circuit

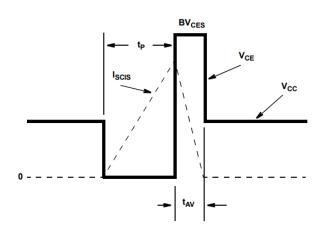
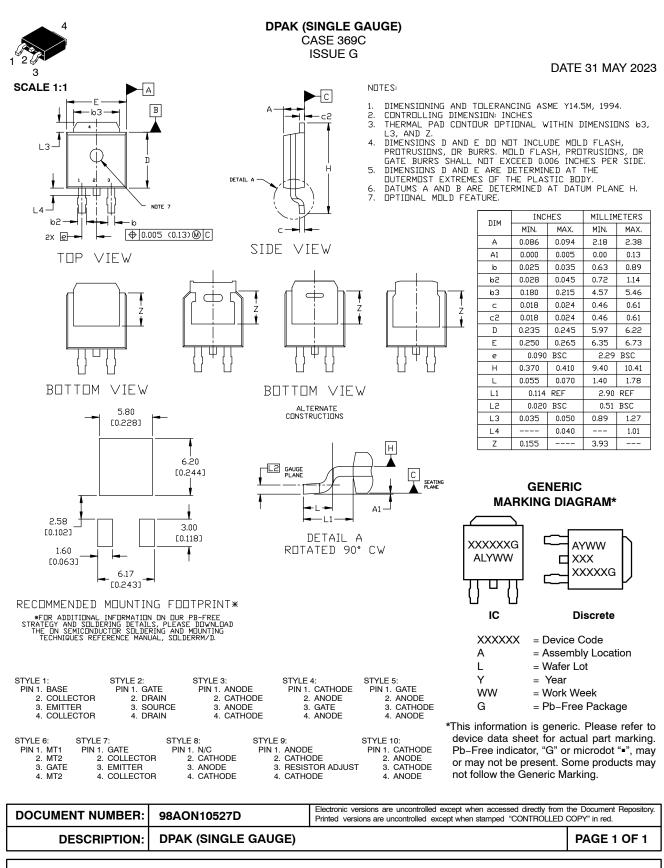


Figure 20. Energy Waveforms

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